

## B. Amendment to the Claims

Please amend claim 1 and as follows:

1. (Currently Amended) A method for manufacturing a liquid jet recording head which comprises an element substrate provided with a plurality of discharge energy generating elements for applying discharging energy to a recording liquid in accordance with image data, a liquid chamber for storing the recording liquid, and a top plate having a plurality of nozzles and which is formed by jointing the element substrate and the top plate so that each of the discharge energy generating elements faces the respective nozzle, the method comprising the steps of:

~~a step of forming, in an anisotropic-etching mask layer provided on a nozzle surface of the top plate, a compensation pattern patterns extending over a portion of the top plate that is subsequently etched away to form the into a liquid chamber for storing the recording liquid region in order to form the nozzles and the liquid chamber by anisotropic etching; and~~

~~over-etching the top plate by anisotropic etching using the compensation pattern as a mask to remove a part of the top plate masked by the compensation pattern prior to removing the compensation pattern to form a step of performing anisotropic etching of the top plate using the compensation patterns as a mask so that (i) the top plate is over-etched; and (ii) the liquid chamber having a substantially rectangular shape at the nozzle surface of the top plate is formed.~~

2. (Original) A method for manufacturing a liquid jet recording head according to claim 1, wherein the top plate comprises a silicon wafer having a <110> oriented surface.

3. (Currently Amended) A method for manufacturing a liquid jet recording head according to one of claims 1 and 2, wherein comb-shaped [[the]] compensation patterns are comb-shaped and are formed and arranged to oppose each other so as to define a ladder-shaped opening region between the compensation patterns at the center portion of a part of the top plate that will be removed to form the liquid chamber region.

4. (Currently Amended) A method for manufacturing a liquid jet recording head according to one of claims 1 and 2, wherein [[the]] compensation patterns are formed and arranged to oppose each other so as to define a substantially H-shaped opening region between the compensation patterns at the center portion of a part of the top plate that will be removed to form the liquid chamber region.

5. (Currently Amended) A method for manufacturing a liquid jet recording head according to one of claims 1 and 2, wherein each of the compensation pattern patterns is designed by combining at least one line having an angle of 55° relative to a <111> plane in the nozzle direction of the silicon wafer and at least one line having an angle of 71° relative to the same <111> plane, and [[the]] compensation patterns are

formed and arranged to oppose each other separated by an opening region in the center portion of a part of the top plate that will be removed to form the liquid chamber region.

6. (Currently Amended) A method for manufacturing a liquid jet recording head according to one of claims 1 and 2, wherein each of the compensation pattern patterns is designed by combining at least one line having an angle of 55° relative to a <111> plane in the nozzle direction of the silicon wafer, at least one line having an angle of 71° relative to the same <111> plane, and at least one line parallel to the nozzle arraying direction, and [[the]] compensation patterns are formed and arranged to oppose each other separated by an opening region in the center portion of a part of the top plate that will be removed to form the liquid chamber region.

7. (Currently Amended) A method for manufacturing a liquid jet recording head according to claim 1, further comprising the step of removing the compensation pattern patterns after the liquid chamber is formed.